



Spec No.: DS20-2013-0032 Effective Date: 03/19/2013

Revision: -

LITE-ON DCC

RELEASE

BNS-OD-FC001/A4

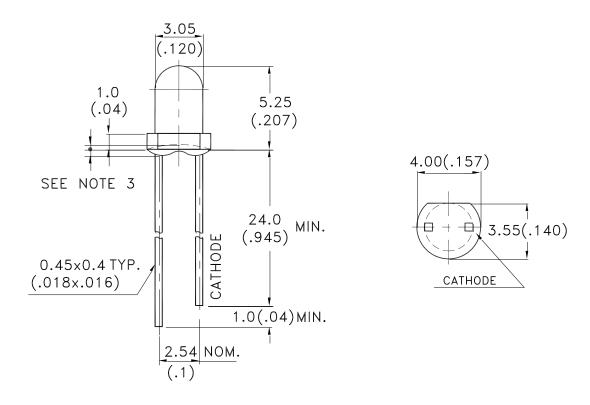


Property of Lite-On Only

Features

- * High luminous intensity output.
- * Low power consumption.
- * High efficiency.
- * Versatile mounting on P.C. Board or panel.
- * I.C. Compatible/low current requirement.
- * 3.1 mm diameter package.

Package Dimensions



Part No.	Lens	Source Color
LTL1NHSJ4D	Amber Diffused	AlInGaP Yellow

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.25 mm(.010") unless otherwise noted.
- 3. Protruded resin under flange is 0.5mm(.02") max and depressed resin under flange is 0.5mm(.02") max.
- 4. Lead spacing is measured where the leads emerge from the package.
- 5. Specifications are subject to change without notice.

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Absolute Maximum Ratings at Ta=25℃

Parameter	Maximum Rating	Unit	
Power Dissipation	75		
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	60 mA		
DC Forward Current	20	mA	
Reverse Voltage	5		
Operating Temperature Range	-40°C to + 85°C		
Storage Temperature Range	-40°C to + 100°C		
Lead Soldering Temperature [1.6mm(.063") From Body]	260°C for 5 Seconds		

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Electrical / Optical Characteristics at TA=25°C

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	Iv	240	700	1150	mcd	I _F = 20mA Note 1
Viewing Angle	201/2		25		deg	Note 2 (Fig.5)
Peak Emission Wavelength	λР		591		nm	Measurement @Peak (Fig.1)
Dominant Wavelength	λd	586	590	594	nm	Note 4
Spectral Line Half-Width	Δλ		15		nm	
Forward Voltage	V _F	1.6	2.1	2.6	V	$I_F = 20 mA$
Reverse Current	I_R			100	μΑ	V _R = 5V Note 5

- NOTE: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
 - 2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
 - 3. Iv classification code is marked on each packing bag.
 - 4. The dominant wavelength, λd is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
 - 5. Reverse voltage (V_R) condition is applied for IR test only. The device is not designed for reverse operation.

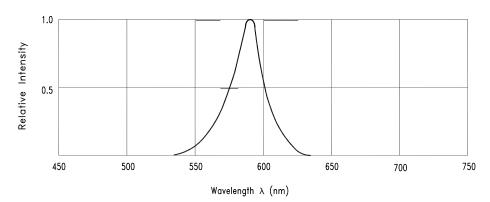
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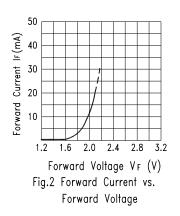
Property of Lite-On Only

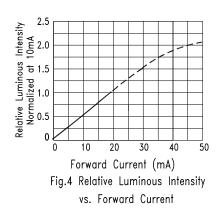
Electrical / Optical Characteristics Curves **Typical**

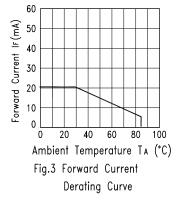
(25°C Ambient Temperature Unless Otherwise Noted)



Relative Intensity vs. Wavelength







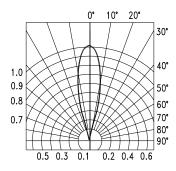


Fig.5 Spatial Distribution

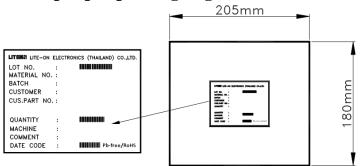
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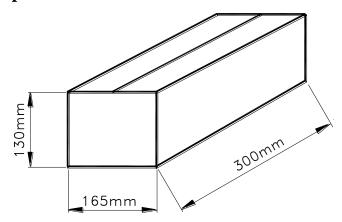
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Packing Spec

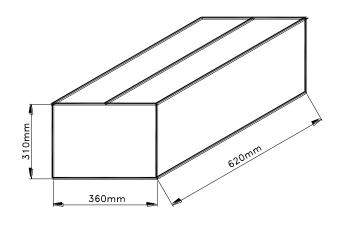
1000, 500, 200 and 100 pcs per packing bag



10 packing bags per inner carton total 10000 pcs per inner carton



8 Inner cartons per outer carton total 80000 pcs per outer carton In every shipping lot, only the last pack will be non-full packing



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Bin Code List For Reference

Luminous Inter	nsity Unit: mcd @20mA		
Bin Code	Min.	Max.	
JK	240	400	
LM	400	680	
NP	680	1150	

Note: Tolerance of each bin limit is $\pm 15\%$

Dominant Wa	velength Uni	t : nm @20mA
Bin Code	Min.	Max.
H16	586.0	588.0
H17	588.0	590.0
H18	590.0	592.0
H19	592.0	594.0

Note: Tolerance of each bin limit is ± 1 nm

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CAUTIONS

1. Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

2. Storage

The storage ambient for the LEDs should not exceed 30°C temperature or 70% relative humidity. It is recommended that LEDs out of their original packaging are used within three months. For extended storage out of their original packaging, it is recommended that the LEDs be stored in

a sealed container with appropriate desiccant or in desiccators with nitrogen ambient.

3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LEDs if necessary.

4. Lead Forming & Assembly

During lead forming, the leads should be bent at a point at least 3mm from the base of LED lens.

Do not use the base of the lead frame as a fulcrum during forming.

Lead forming must be done before soldering, at normal temperature.

During assembly on PCB, use minimum clinch force possible to avoid excessive mechanical stress.

5. Soldering

When soldering, leave a minimum of 2mm clearance from the base of the lens to the soldering point. Dipping the lens into the solder must be avoided.

Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering conditions:

Solderi	ng iron	Wave soldering		
Temperature Soldering time	350°C Max. 3 sec. Max. (one time only)	Pre-heat Pre-heat time Solder wave Soldering time	100°C Max. 60 sec. Max. 260°C Max. 5 sec. Max.	

Note: Excessive soldering temperature and/or time might result in deformation of the LED lens or catastrophic failure of the LED. IR reflow is not suitable process for through hole type LED lamp product.

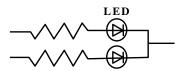
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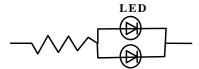
6. Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.

Circuit model A



Circuit model B



- (A) Recommended circuit
- (B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs

7. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED.

Suggestions to prevent ESD damage:

- Use a conductive wrist band or anti- electrostatic glove when handling these LEDs
- All devices, equipment, and machinery must be properly grounded
- Work tables, storage racks, etc. should be properly grounded
- Use ion blower to neutralize the static charge which might have built up on surface of the LEDs plastic lens as a result of friction between LEDs during storage and handing

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Suggested checking list:

Training and Certification

- 1. Everyone working in a static-safe area is ESD-certified?
- 2. Training records kept and re-certification dates monitored?

Static-Safe Workstation & Work Areas

- 1. Static-safe workstation or work-areas have ESD signs?
- 2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
- 3. All ionizer activated, positioned towards the units?
- 4. Each work surface mats grounding is good?

Personnel Grounding

- 1. Every person (including visitors) handling ESD sensitive (ESDS) items wear wrist strap, heel strap or conductive shoes with conductive flooring?
- 2. If conductive footwear used, conductive flooring also present where operator stand or walk?
- 3. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V*?
- 4. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DLs?
- 5. All wrist strap or heel strap checkers calibration up to date? Note: *50V for Blue LED.

Device Handling

- 1. Every ESDS items identified by EIA-471 labels on item or packaging?
- 2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
- 3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
- 4. All flexible conductive and dissipative package materials inspected before reuse or recycle?

Others

- 1. Audit result reported to entity ESD control coordinator?
- 2. Corrective action from previous audits completed?
- 3. Are audit records complete and on file?

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8.	Re	liat	ili	ty	Test
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Classification	Test Item	Test Condition	Reference Standard
	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating Test Time= 1000HRS	MIL-STD-750D:1026 MIL-STD-883G:1005
Endurance Test	High Temperature High Humidity Storage	Ta= 60°C RH= 90% Test Time= 240HRS	MIL-STD-202G:103B JEITA ED-4701:100 103
Endurance Test	High Temperature Storage	Ta= 105±5°C Test Time= 1000HRS	MIL-STD-750D:1031 MIL-STD-883G:1008 JEITA ED-4701:200 201
	Low Temperature Storage	Ta= -55±5°C Test Time=1000HRS	JEITA ED-4701:200 202
	Temperature Cycling	100°C ~ 25°C~ -40°C ~ 25°C 30mins 5mins 30mins 5mins 30 Cycles	MIL-STD-750D:1051 MIL-STD-883G:1010 JEITA ED-4701:100 105 JESD22-A104C
	Thermal Shock	105 ± 5°C ~ -30°C ± 5°C 15mins ~ 15mins 30 Cycles (< 20 secs transfer)	MIL-STD-750D:1056 MIL-STD-883G:1011 MIL-STD-202G: 107G JESD22-A106B
Environmental Test	Solder Resistance	T.sol = $260 \pm 5^{\circ}$ C Max. Dwell Time = 10 ± 1 sec	MIL-STD-750D:2031 JEITA ED-4701:300 302
	Solderability	T. sol = $245 \pm 5^{\circ}C$ Dwell Time= 5 ± 0.5 sec (Lead Free Solder, Coverage $\geq 95\%$ of the dipped surface)	MIL-STD-750D:2026 MIL-STD-883G:2003 MIL-STD-202G: 208H IPC/EIA J-STD-002
	Soldering Iron	T. sol = $350 \pm 5^{\circ}$ C Dwell Time= 3.5 ± 0.5 sec	MIL-STD-202G: 208H JEITA ED-4701:300 302

9. Others

The appearance and specifications of the product may be modified for improvement, without prior notice.

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